Silicon N-Channel Power MOS FET Array

HITACHI

Application

High speed power switching

Features

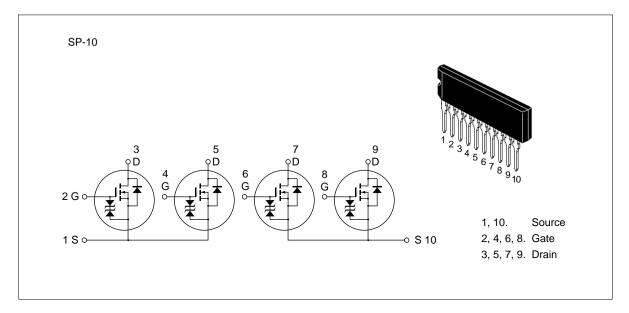
• Low on-resistance

$$R_{DS(on)} \le 0.07$$
 , $V_{GS} = 10$ V, $I_D = 8$ A $R_{DS(on)} \le 0.095$, $V_{GS} = 4$ V, $I_D = 8$ A

- Capable of 4 V gate drive
- Low drive current
- High speed switching
- High density mounting
- Suitable for motor driver, solenoid driver and lamp driver



Outline



Absolute Maximum Ratings ($Ta = 25^{\circ}C$) (1 Unit)

Item	Symbol	Rating	Unit
Drain to source voltage	V _{DSS}	±60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	8	A
Drain peak current	I _{D(pulse)} *1	32	A
Body to drain diode reverse drain current	I _{DR}	8	A
Channel dissipation	Pch (Tc = 25°C)*2	28	W
Channel dissipation	Pch*2	4	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

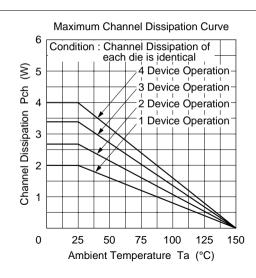
Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

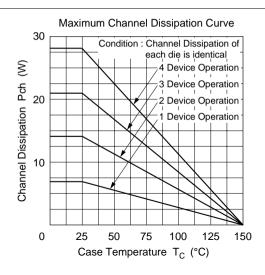
2. 4 devices operation

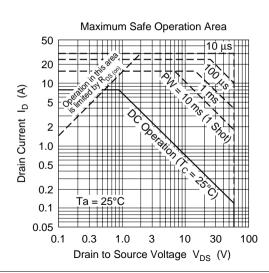
Electrical Characteristics (Ta = 25°C) (1 Unit)

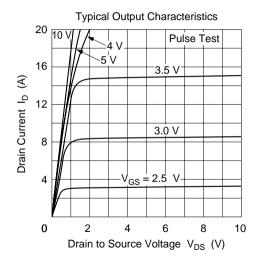
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	250	μΑ	$V_{DS} = 50 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{\rm GS(off)}$	1.0	_	2.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	_	0.055	0.07	Ω	$I_D = 8 A$ $V_{GS} = 10 V^{*1}$
		_	0.075	0.095	Ω	$I_D = 8 A$ $V_{GS} = 4 V^{*1}$
Forward transfer admittance	$ y_{fs} $	7	12	_	S	$I_D = 8 A$ $V_{DS} = 10 V^{*1}$
Input capacitance	Ciss	_	860	_	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	Coss	_	450	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	140	_	pF	f = 1 MHz
Turn-on delay time	$t_{d(on)}$	_	10	_	ns	$I_D = 8 A$
Rise time	t _r	_	70	_	ns	V _{GS} = 10 V
Turn-off delay time	$t_{\text{d(off)}}$	_	180	_	ns	$R_L = 3.75 \Omega$
Fall time	t _f	_	120	_	ns	
Body to drain diode forward voltage	V_{DF}	_	1.05	_	V	$I_F = 8 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}	_	110	_	ns	$I_F = 8 \text{ A}, V_{GS} = 0$ $dIF/dt = 50 \text{ A}/\mu s$

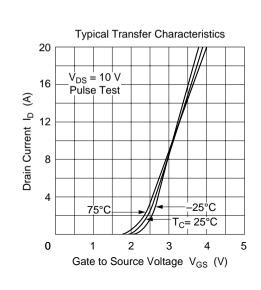
Note: 1. Pulse test

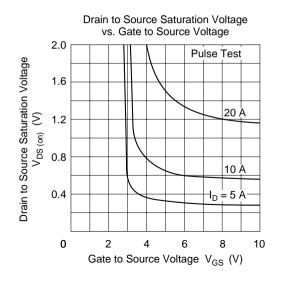


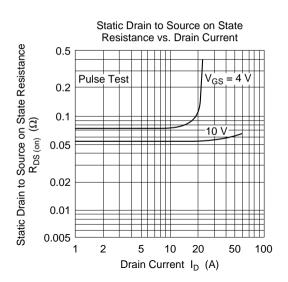


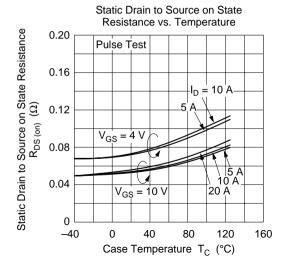


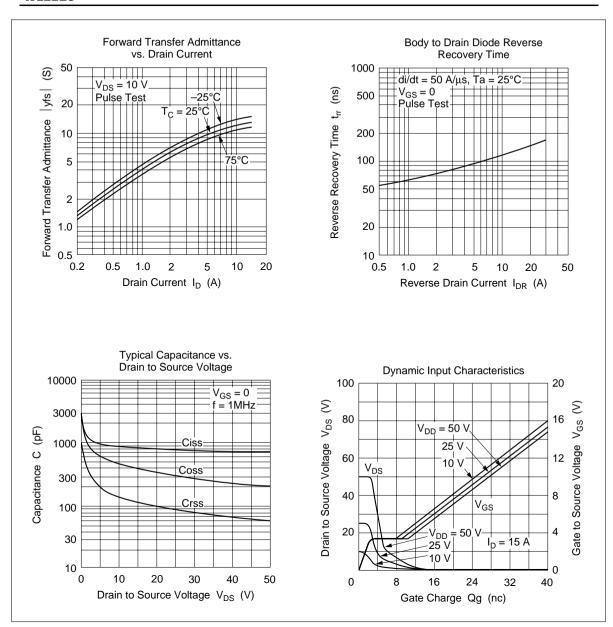


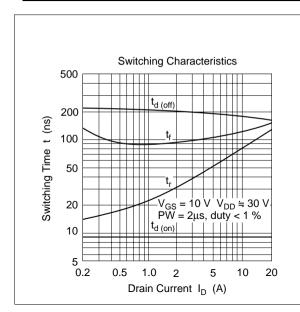


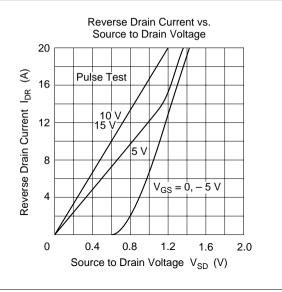




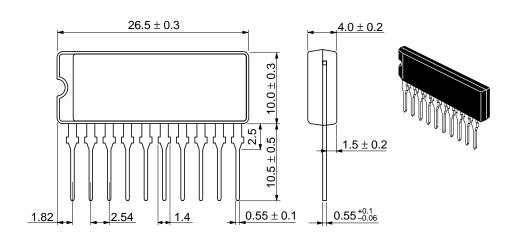








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Hitachi Code	SP-10
JEDEC	
EIAJ	
Weight (reference value)	2.9 g

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Hitachi, Ltd.

Semiconductor & Integrated Circuits.

Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

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For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose,CA 95134 Tel: <1> (408) 433-1990 Fax: <1>(408) 433-0223 Hitachi Europe GmbH Electronic components Group Dornacher Stra§e 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0

Fax: <49> (89) 9 29 30 00 Hitachi Europe Ltd. Electronic Components Group.

Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA, United Kingdom

Tel: <44> (1628) 585000 Fax: <44> (1628) 778322 Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 049318 Tel: 535-2100 Fax: 535-1533

Hitachi Asia Ltd. Taipei Branch Office 3F, Hung Kuo Building. No.167, Tun-Hwa North Road, Taipei (105) Tel: <886> (2) 2718-3666 Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road, Tsim Sha Tsui, Kowloon, Hong Kong Tel: <852> (2) 735 9218

Fax: <852> (2) 730 0281 Telex: 40815 HITEC HX

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